

**DESCRIPTION****700V Super-Junction Power MOSFET****700V super-junction Power MOSFET**

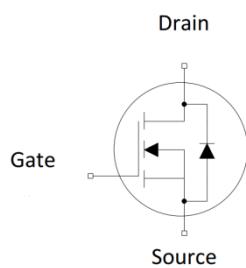
Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The SJ MOSFET is a price-performance optimized product enabling to target cost sensitive applications in Consumer and Lighting markets, designed by Wuxi Unigroup Microelectronics Company.

**FEATURES**

- Ultra-fast body diode
- Very low FOM  $R_{DS(on)} \times Q_g$
- 100% avalanche tested
- RoHS compliant

**APPLICATIONS**

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

**Device Marking and Package Information**

Device	Package	Marking
TPW70R100MFD	TO-247	70R100MFD

**Key Performance Parameters**

Parameter	Value	Unit
$V_{DS} @ T_{j,max}$	700	V
$R_{DS(on),max}$	0.1	$\Omega$
$I_D$	47	A
$Q_{g,typ}$	75	nC
$I_{DM}$	141	A
$t_{rr}$	145	ns
$Q_{rr}$	0.87	$\mu C$
$I_{rm}$	12	A

**Absolute Maximum Ratings  $T_C = 25^\circ\text{C}$ , unless otherwise noted**

Parameter	Symbol	Value	Unit
Drain-Source Voltage ( $V_{GS} = 0\text{V}$ )	$V_{DSS}$	700	V
Continuous Drain Current $T_C = 25^\circ\text{C}$	$I_D$	47	A
$T_C = 100^\circ\text{C}$		28.2	
Pulsed Drain Current (note1)	$I_{DM}$	141	A
Gate-Source Voltage	$V_{GSS}$	$\pm 30$	V
Single Pulse Avalanche Energy (note2)	$E_{AS}$	1160	mJ
Repetitive Avalanche Energy (note2)	$E_{AR}$	1.76	mJ
Avalanche Current	$I_{AR}$	8.7	A
MOSFET dv/dt ruggedness, $V_{DS} = 0 \dots 480\text{V}$	dv/dt	50	V/ns
Power Dissipation	$P_D$	391	W
Continuous Body Diode Current	$I_S$	40	A
Pulsed Diode Forward Current (note1)	$I_{SM}$	141	
Reverse diode dv/dt (note3)	dv/dt	50	V/ns
Maximum diode commutation speed (note3)	di/dt	900	A/us
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55~+150	$^\circ\text{C}$

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	$R_{thJC}$	0.32	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	62	

**Specifications**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

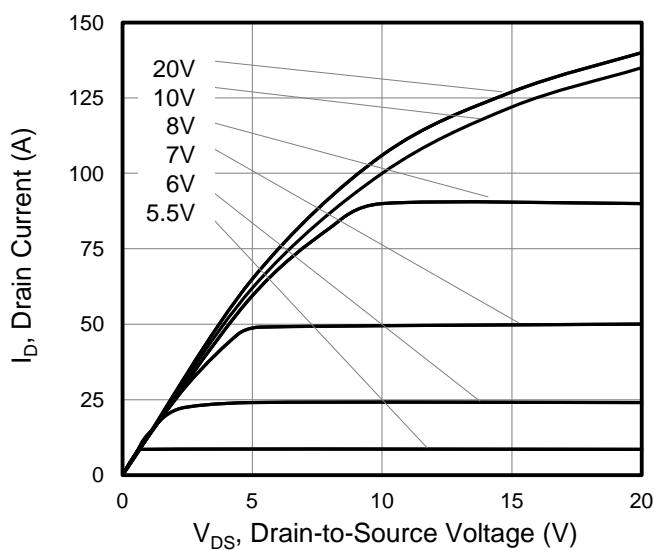
Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	700	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 700\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 25^\circ\text{C}$	--	--	5	$\mu\text{A}$
		$V_{\text{DS}} = 700\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 150^\circ\text{C}$	--	--	5000	
Gate-Source Leakage	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 30\text{V}$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	3	--	5	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 24\text{A}$	--	0.088	0.1	$\Omega$
Gate resistance	$R_G$	f = 1.0MHz open drain	--	0.8	--	$\Omega$
<b>Dynamic</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 100\text{V}, f = 1.0\text{MHz}$	--	3587	--	$\text{pF}$
Output Capacitance	$C_{\text{oss}}$		--	106	--	
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	2.6	--	
Total Gate Charge	$Q_g$	$V_{\text{DD}} = 520\text{V}, I_D = 47\text{A}, V_{\text{GS}} = 10\text{V}$	--	78	--	$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$		--	24	--	
Gate-Drain Charge	$Q_{\text{gd}}$		--	32	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 400\text{V}, I_D = 47\text{A}, R_G = 25\Omega$	--	49	--	$\text{ns}$
Turn-on Rise Time	$t_r$		--	123	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	105	--	
Turn-off Fall Time	$t_f$		--	49	--	
<b>Drain-Source Body Diode Characteristics</b>						
Body Diode Voltage	$V_{\text{SD}}$	$T_J = 25^\circ\text{C}, I_{\text{SD}} = 24\text{A}, V_{\text{GS}} = 0\text{V}$	--	0.9	1.2	V
Reverse Recovery Time	$t_{\text{rr}}$	$V_R = 400\text{V}, I_F = 23\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$	--	145	--	$\text{ns}$
Reverse Recovery Charge	$Q_{\text{rr}}$		--	0.87	--	$\mu\text{C}$
Peak Reverse Recovery Current	$I_{\text{rrm}}$		--	12	--	A

**Notes**

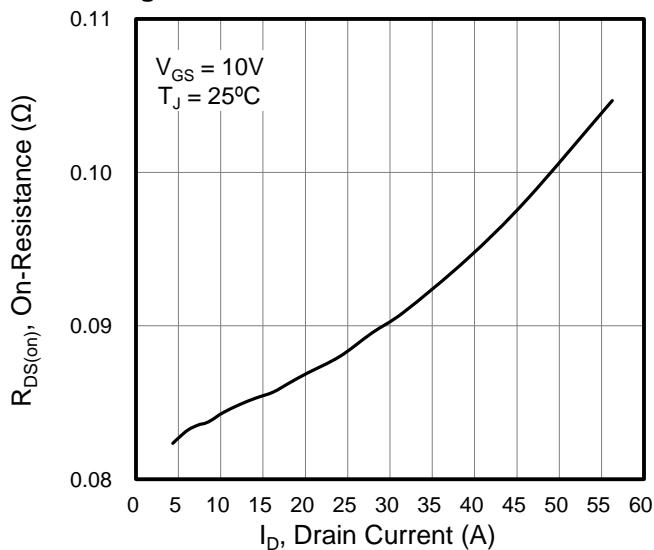
1. Repetitive Rating: Pulse width limited by maximum junction temperature
2.  $I_{\text{AS}} = 8.7\text{A}, V_{\text{DD}} = 50\text{V}, R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$
3. Identical low side and high side switch with identical  $R_G$

**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

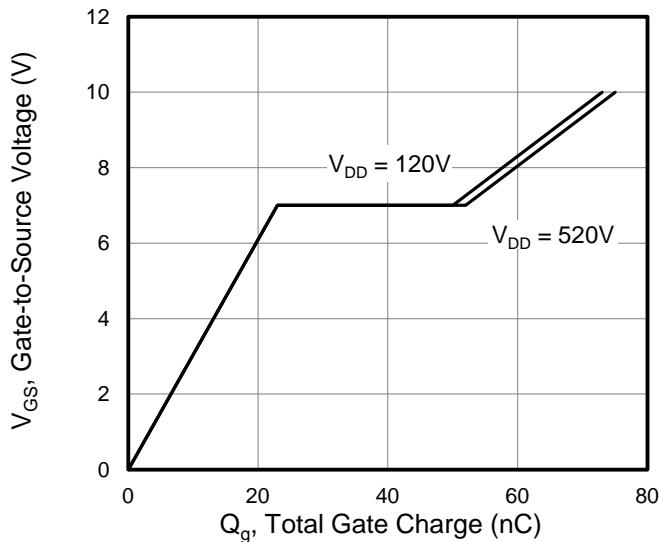
**Figure 1. Output Characteristics**



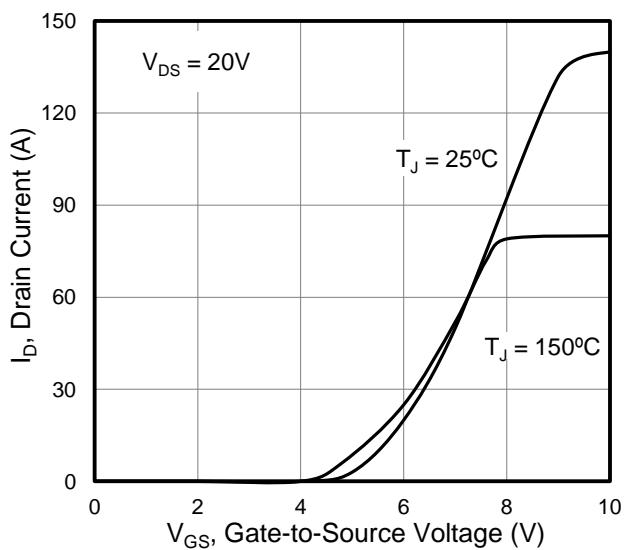
**Figure 3. On-Resistance vs. Drain Current**



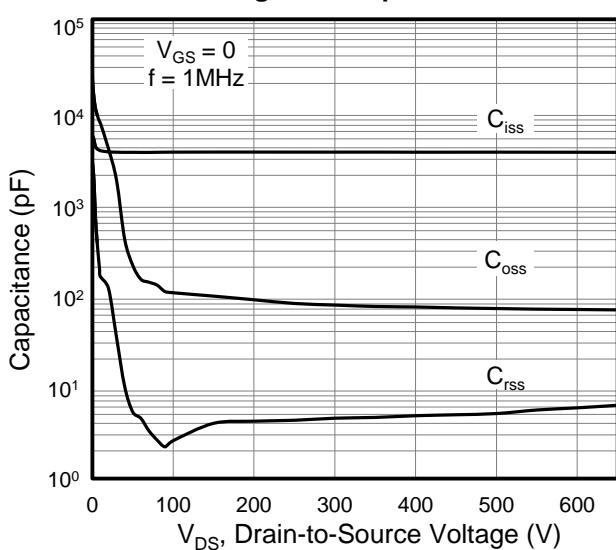
**Figure 5. Gate Charge**



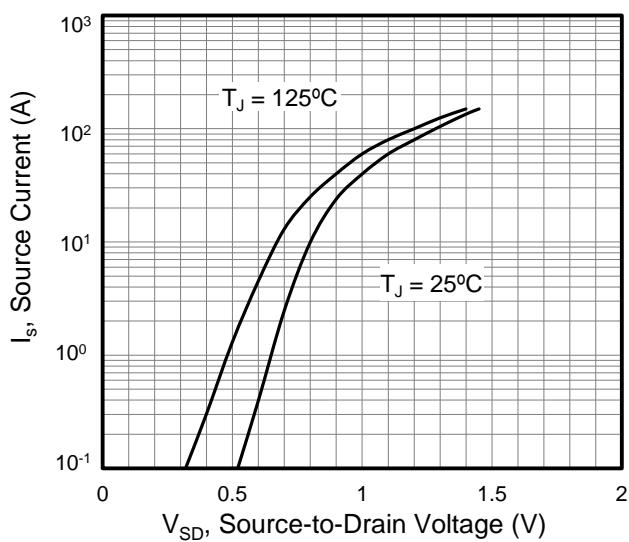
**Figure 2. Transfer Characteristics**



**Figure 4. Capacitance**

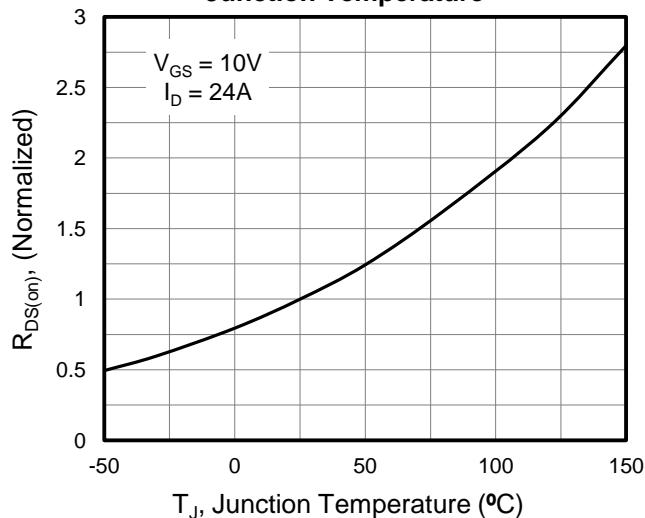


**Figure 6. Body Diode Forward Voltage**

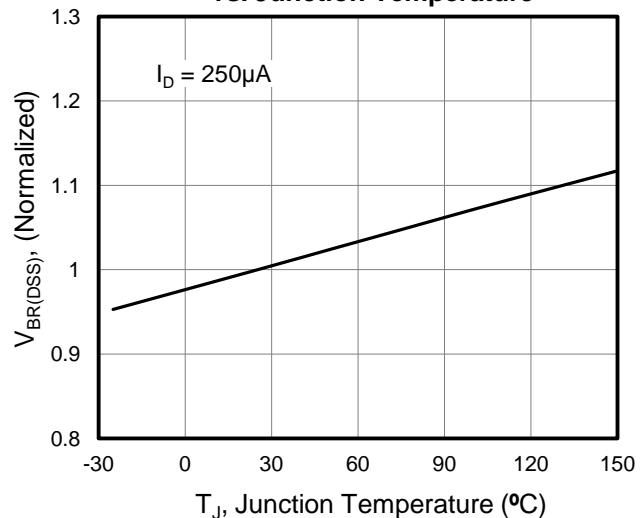


**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

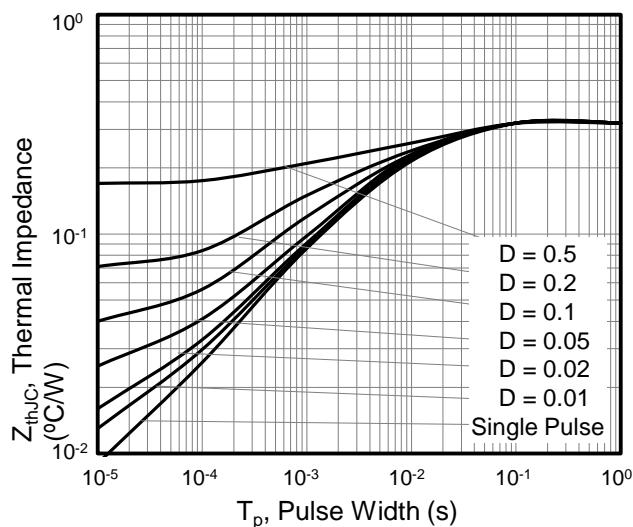
**Figure 7. On-Resistance vs. Junction Temperature**



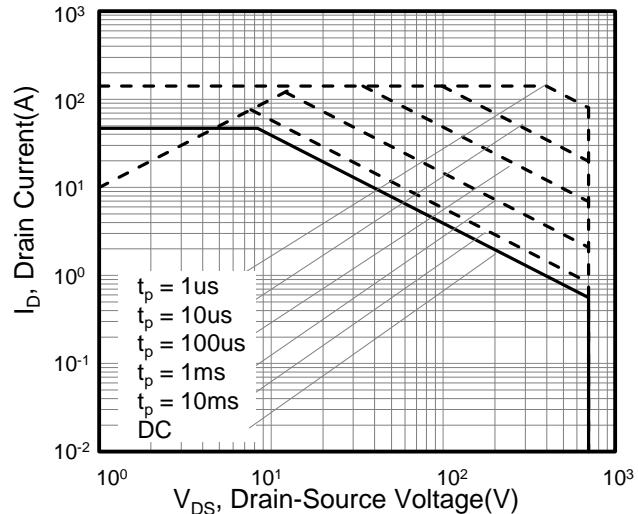
**Figure 8. Breakdown voltage vs. Junction Temperature**

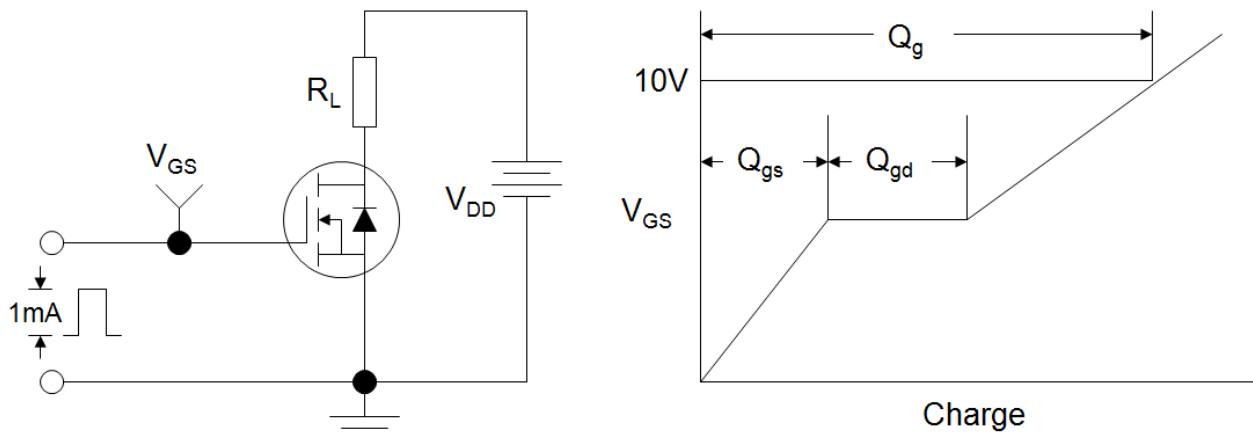
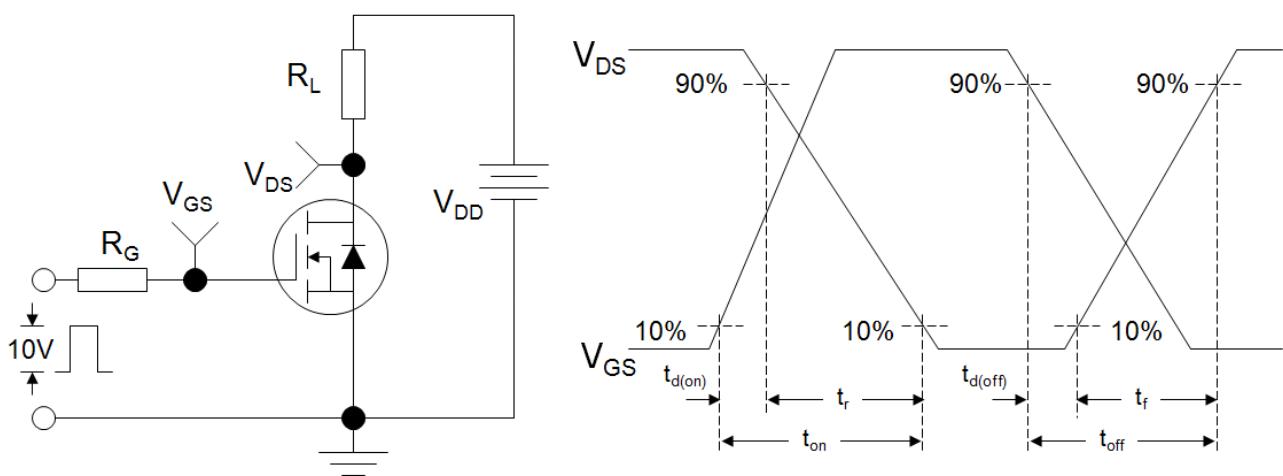
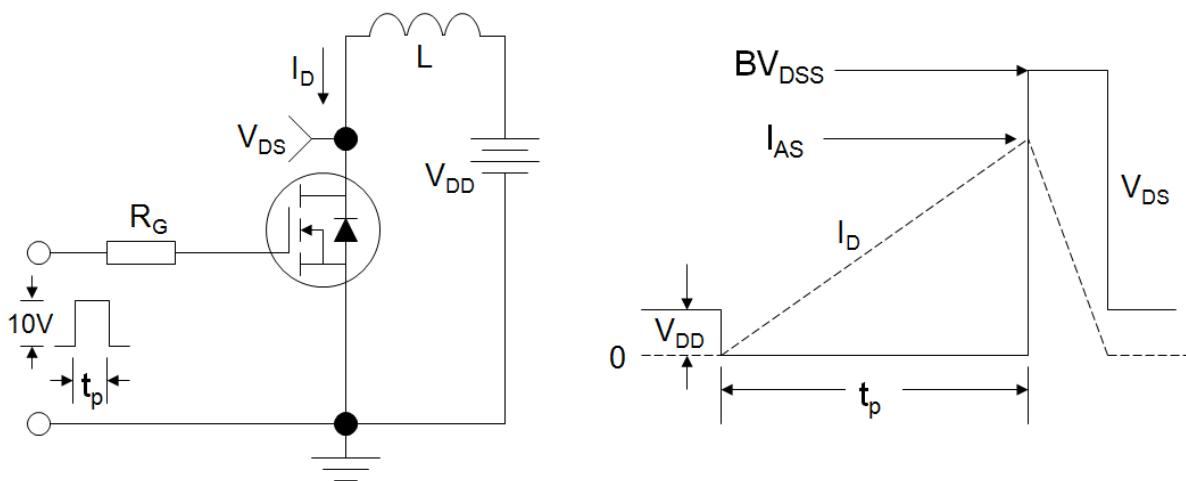


**Figure 9 . Transient Thermal Impedance for TO-247**



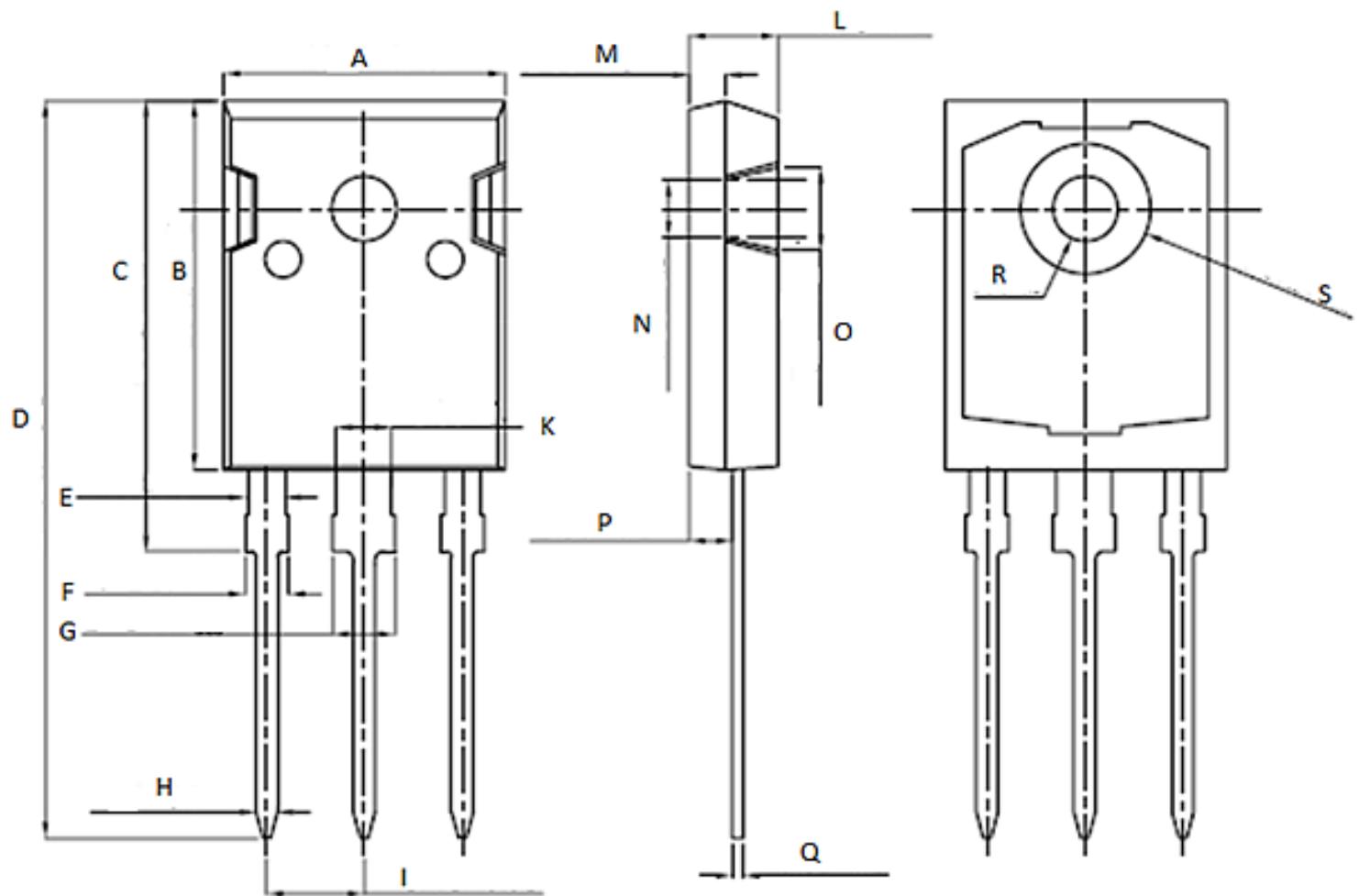
**Figure 10. Safe operation area for TO-247**



**Figure A: Gate Charge Test Circuit and Waveform**

**Figure B: Resistive Switching Test Circuit and Waveform**

**Figure C: Unclamped Inductive Switching Test Circuit and Waveform**




## TO-247



Unit:mm		
Symbol	Min.	Max.
A	15.95	16.25
B	20.85	21.25
C	20.95	21.35
D	40.50	40.90
E	1.90	2.10
F	2.10	2.25
G	3.10	3.25
H	1.10	1.30
I	5.40	5.50

Unit:mm		
Symbol	Min.	Max.
K	2.90	3.10
L	4.90	5.30
M	1.90	2.10
N	4.50	4.70
O	5.40	5.60
P	2.29	2.49
Q	0.51	0.71
R	Φ3.50	Φ3.70
S	Φ7.10	Φ7.30



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